



Cohu to Present at Upcoming Investor Conferences

May 18, 2026

SAN DIEGO--(BUSINESS WIRE)--May 18, 2026-- Cohu, Inc. (NASDAQ: COHU), a global supplier of equipment and services optimizing semiconductor manufacturing yield and productivity, today announced that management will participate at the following investor conferences:

TD Cowen 54th Annual Technology, Media & Telecom Conference

Location: InterContinental New York Barclay, New York, NY

May 27, 2026

23rd Annual Craig-Hallum Institutional Investor Conference

Location: Depot Renaissance Hotel Minneapolis, MN

May 28, 2026

Stifel 2026 Cross Sector Insight Conference

Location: InterContinental Boston, MA

June 2, 2026

2026 Evercore Global TMT Conference

Location: the Omni San Francisco Hotel in San Francisco, CA

June 3, 2026

Portfolio managers and analysts should contact their respective banking representative to schedule a meeting at these conferences.

Presentation materials will be made concurrently available on the Investor Relations section of the Company's website, www.cohu.com.

About Cohu:

Cohu (NASDAQ: COHU) was founded in 1947 and is a global technology leader supplying test, automation, inspection & metrology products, software analytics solutions and services to the semiconductor industry. Additional information can be found at www.cohu.com.

For press releases and other information of interest to investors, please visit Cohu's website at www.cohu.com.

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Investor Relations

Source: Cohu, Inc.